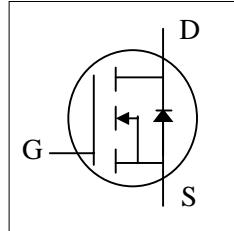
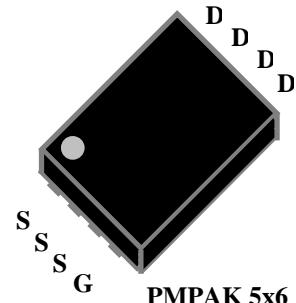




- ▼ Simple Drive Requirement
- ▼ SO-8 Compatible with Heatsink
- ▼ Low On-resistance
- ▼ RoHS Compliant



$BV_{DSS}$	30V
$R_{DS(ON)}$	3.3mΩ
$I_D$	105A



## Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The PMPAK 5x6 package is special for DC-DC converters application and the foot print is compatible with SO-8 with backside heat sink and lower profile.

## Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	+20	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current (Chip)	105	A
$I_D @ T_A = 25^\circ C$	Continuous Drain Current <sup>3</sup>	31	A
$I_D @ T_A = 70^\circ C$	Continuous Drain Current <sup>3</sup>	25	A
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	250	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	56.8	W
$P_D @ T_A = 25^\circ C$	Total Power Dissipation	5	W
$E_{AS}$	Single Pulse Avalanche Energy <sup>4</sup>	28.8	mJ
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

## Thermal Data

Symbol	Parameter	Value	Units
$R_{thj-c}$	Maximum Thermal Resistance, Junction-case	2.2	°C/W
$R_{thj-a}$	Maximum Thermal Resistance, Junction-ambient <sup>3</sup>	25	°C/W



# AP3R303GMT-HF

## Electrical Characteristics@ $T_j=25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance <sup>2</sup>	$V_{GS}=10V, I_D=30A$	-	-	3.3	$m\Omega$
		$V_{GS}=4.5V, I_D=20A$	-	-	5	$m\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	-	3	V
$g_{fs}$	Forward Transconductance	$V_{DS}=10V, I_D=20A$	-	60	-	S
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=30V, V_{GS}=0V$	-	-	1	$\mu A$
$I_{GSS}$	Gate-Source Leakage	$V_{GS}=\pm 20V$	-	-	$\pm 100$	nA
$Q_g$	Total Gate Charge <sup>2</sup>	$I_D=30A$	-	13.3	21	nC
$Q_{gs}$	Gate-Source Charge	$V_{DS}=15V$	-	2.5	-	nC
$Q_{gd}$	Gate-Drain ("Miller") Charge	$V_{GS}=4.5V$	-	7.2	-	nC
$t_{d(on)}$	Turn-on Delay Time <sup>2</sup>	$V_{DS}=15V$	-	8	-	ns
$t_r$	Rise Time	$I_D=1A$	-	5.5	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=3.3\Omega, V_{GS}=10V$	-	25	-	ns
$t_f$	Fall Time	$R_D=15\Omega$	-	17	-	ns
$C_{iss}$	Input Capacitance	$V_{GS}=0V$	-	1400	2240	pF
$C_{oss}$	Output Capacitance	$V_{DS}=25V$	-	440	-	pF
$C_{rss}$	Reverse Transfer Capacitance	f=1.0MHz	-	170	-	pF
$R_g$	Gate Resistance	f=1.0MHz	-	1.4	2.1	$\Omega$

## Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{SD}$	Forward On Voltage <sup>2</sup>	$I_S=30A, V_{GS}=0V$	-	-	1.2	V
$t_{rr}$	Reverse Recovery Time <sup>2</sup>	$I_S=10A, V_{GS}=0V,$ $dI/dt=100A/\mu s$	-	35	-	ns
			-	32	-	nC

## Notes:

- 1.Pulse width limited by Max. junction temperature
- 2.Pulse test
- 3.Surface mounted on 1 in<sup>2</sup> copper pad of FR4 board, t  $\leq$  10sec, 60°C/W at steady state.
- 4.Starting  $T_j=25^\circ C$  ,  $V_{DD}=25V$  ,  $L=0.1mH$  ,  $R_G=25\Omega$  ,  $I_{AS}=24A$ .

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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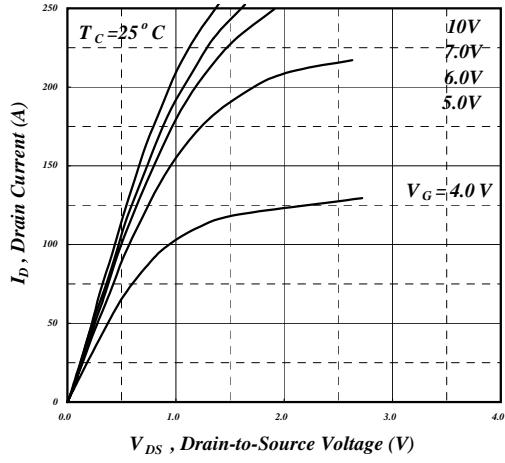


Fig 1. Typical Output Characteristics

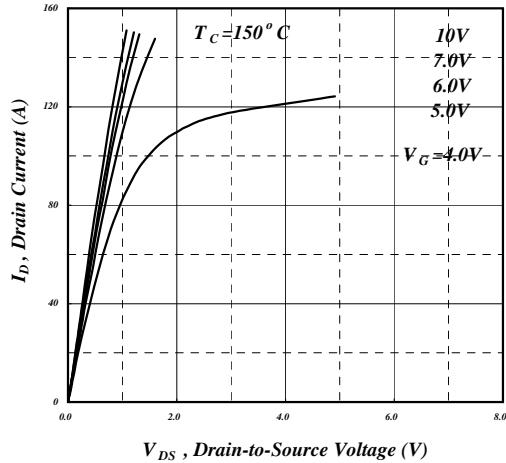


Fig 2. Typical Output Characteristics

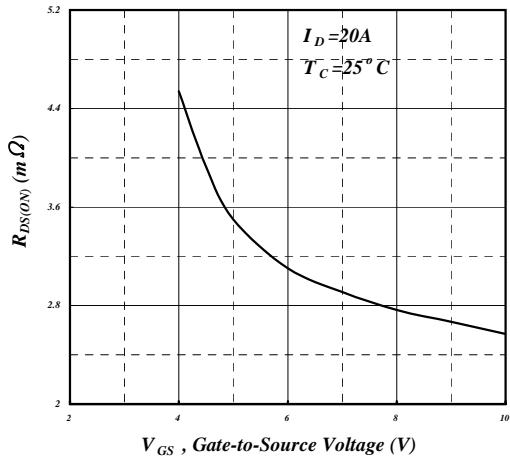


Fig 3. On-Resistance v.s. Gate Voltage

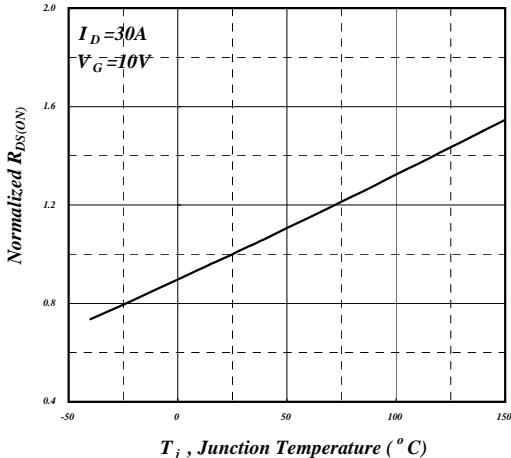


Fig 4. Normalized On-Resistance v.s. Junction Temperature

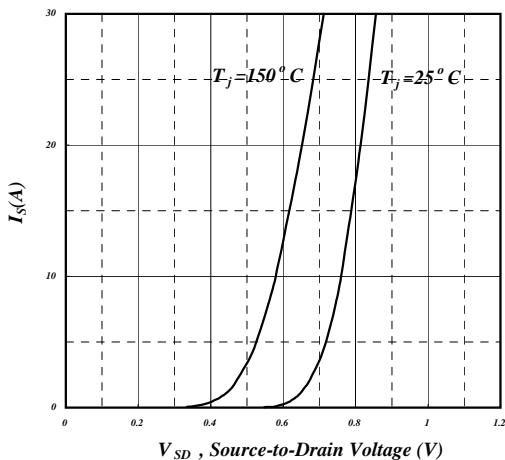


Fig 5. Forward Characteristic of Reverse Diode

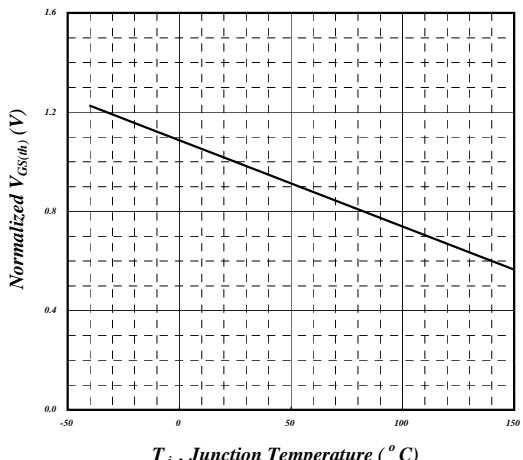


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

